



SPECIFICATION

Crystal Unit

NX2016SA

Customer:

Item:

Туре:

Nominal Frequency: 26.000 MHz

Customer's Spec. No .:

NDK Spec. No.: EXS00A-CS08835

Receipt

Charge:

<u>ea.ge.</u>	-	
Sales		
Engineer		

	Revision Record							
Rev.	Date	Items	Contents	Approved	Checked	Drawn		
	27.Mar.2015	Issue		H.Kobayashi	M.Harada	N.Wakisaka		
А	28.May.2015	4.5 Equivalent resistance	Revise : 120 Ω Max. \rightarrow 60 Ω Max.	H.Kobayashi	K.Komada	N.Wakisaka		
В	4.Jun.2015	4.9 Level of drive	Add : 0.01µW Min.	H.Kobayashi	K.Komada	N.Wakisaka		

1. Customer's Spec. No.

2. NDK Spec. No.

: EXS00A-CS08835

3. Туре

: NX2016SA

:

4. Electrical Specifications

	Parameters		Electrical Spec.				Notes	
	T arameters	SYM.	min	typ	max	Units	NOLES	
1	Nominal frequency	f nom		26.000		MHz		
2	Overtone order	-	Fu	ndamer	ntal	-		
3	Frequency tolerance	-	-15	-	+15	ppm	at +25°C	
4	Frequency versus temperature characteristics	-	-50	-	+50	ppm	at -40~+125°C The reference temperature shall be +25°C	
5	Equivalent resistance	-	-	-	60	Ω	IEC π -Network Series	
6	Shunt capacitance	C ₀	-30%	0.61	+30%	pF	Not grounded	
7	Motional capacitance	C ₁	-30%	1.52	+30%	fF	Not grounded	
8	Load capacitance	CL	-	8	-	pF	IEC π -Network	
9	Level of drive	-	0.01	10	200	μW		
10	Insulation resistance	-	500	-	-	MΩ	When terminal to terminal and terminal to cover were applied at DC100V ±15V.	
11	Operating temperature range	T _{opr}	-40	-	+125	°C		
12	Storage temperature range	T _{str}	-40	-	+125	°C		
13	Air-tightness	-	-	-	1.1×10 ⁻⁹	Pa m ³ /s	Helium leak detector	

5. Examination results document

Since a performance is guaranteed, an examination results document does not submit.

6. Application drawing

6.1 External dimension	: EXD14B-00467
6.2 Taping and reel figure	: EXK17B-00200
6.3 Holder marking	: EXH11B-00319
6.4 Reliability assurance Item	: EXS30B-00499
6.5 Recommendation reflow profile	: EXS30B-00344

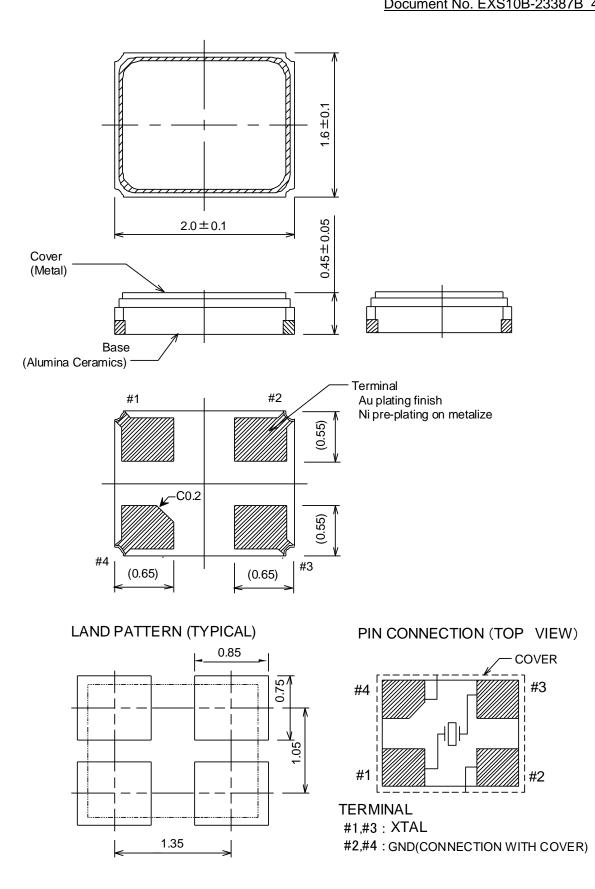
7. Notice

- 7.1 Order items are manufactured according to specification. As to conditions, which are not indicated in this specification and unpredictable such as applied condition and oscillation margin, please check them beforehand.
- 7.2 Unless we receive request for modification within 3 weeks from the issue date of this NDK specification sheet, we will supply products according to this specification. Also, if you'd like to modify specification of order, which has been placed with delivery request within 3 weeks from the issue data of this specification sheet, we would like to discuss with you separately.
- 7.3 In no event shall the company be liable for any product failure resulting from an inappropriate handling or operation of the product beyond the scope of its guarantee.
- 7.4 Where any change to the process condition is made due to the change(s) in the production line, inform personnel of the specifications.
- 7.5 Should this specification data give rise to any disputes relating to any intellectual property rights or any other rights of a third person, the company shall not indemnify anyone for any damage. Their disclosure must not be construed as the grant of a license to use any of the intellectual property rights owned by the company.
- 7.6 If you intend to use products listed on this specification for applications that may result in loss of life or assets (controls relating to safety, medical equipment, aeronautical equipment, space equipment, etc.), please do not fail to advise us of your intention beforehand.
- 7.7 In the company's production process whatever amount of ozone depleting substances (ODS) as specified in the Montreal protocol is not used.
- 7.8 Information contained in this specification must not be quoted, reproduced or used for other purposes including processing either in part or in full without obtaining prior approval from the company.
- 7.9 Crystal units will be damaged by ultrasonic welding process due to resonance of crystal wafer itself. NDK does not recommend using ultrasonic welding. If Ultra Sonic welding used, NDK strongly recommend verifying crystal unit damage by ultrasonic weld.
- 7.10 In case of the product long time keep at high temperature and humidity, may affect product characteristic (solder ability) and a packing condition. Please keep at storage condition of temperature +5°C ~+35°C, humidity ~85%RH.

8. Prohibited items

Be sure to use the product under the following conditions. Otherwise, the characteristics deterioration or destruction of the product may result.

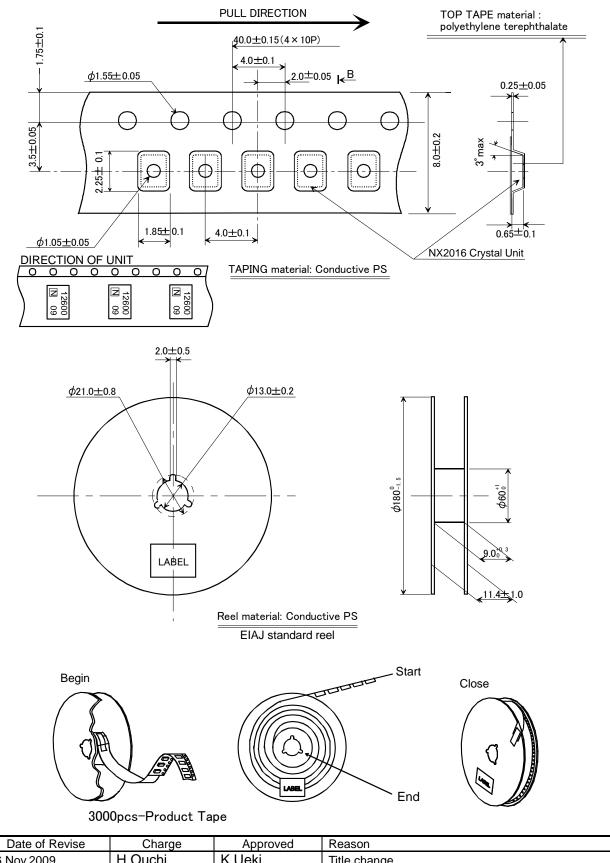
- (1) Reflow soldering heat resistance Peak temperature: 265°C, 10 sec Heating: 230°C or higher, 40 sec Preheating: 150°C to 180°C, 120 sec Reflow passage times: twice
- (2) Manual soldering heat resistance Pressing a soldering iron of 400°C on the terminal electrode for four seconds (twice).



	Dat	e of Revise	Charge	Approved	Reaso	on				
А	15	.Feb.2011	H.Ouchi	K.Ueki	Index position correction.					
		Date	Name	Third Angle Projection		Tolerance		ale		
Draw	n	19.Oct.2009	M.Harada	Dimension:mm					/	
Desi	gned	19.Oct.2009	M.Harada	Title			Drawing No.		Rev.	
Chec	ked			NX201	6SA				•	
Appr	oved	20.Oct.2009	K.Ueki	Dimension Drawing		ng	EXD14B-00467		A	
	NIHON DEMPA KOGYO CO., LTD.									

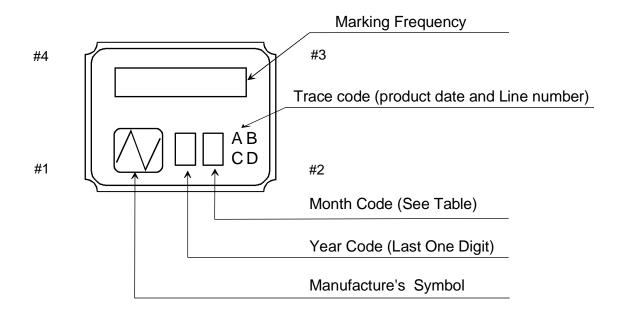
Form M-1

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	Dai		Charge	Appioveu	Reason			
А	26.No\	.2009	H.Ouchi	K.Ueki	Title chang	e		
		Date	Name	Third Angle Projection To		Tolerance	Sc	ale
Drav	vn	12.Apr.2005	K.Oguri	Dimension:mm				/
Des	igned	12.Apr.2005	K.Oguri	Title		Drawing No.		Rev.
Che	cked			NX2016 \$	Series	EXK17B-	00000	^
Арр	roved	12.Apr.2005	K. Miyashita	Taping and Reel Spec.			00200	A

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NOTE

1. Month Code Table

Month	1	2	3	4	5	6	7	8	9	10	11	12
	Jan.	Feb.	Mar.	Apr.	May.	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.
Month Code	1	2	3	4	5	6	7	8	9	Х	Y	Z

*Marking digits are not include a decimal point and dot mark.

	Dat	e of Revise	Charge	Approved	Reason				
Α	10	. Jul. 2008	T.Asamizu	u K.Kubota Delete application period.					
		Date	Name	Third Angle Projection Tol		olerance	Sc	ale	
Draw	/n	14. Feb. 2006	T.Asamizu	Dimension:mm			,	/	
Desi	igned	14. Feb. 2006	T.Asamizu	Title			Drawing No.		Rev.
Che	cked	14. Feb. 2006	I.Miyahara	Crystal Halds	or Mark	dina		00210	٨
Аррі	roved	14. Feb. 2006	K.Okamoto	Crystal Holder Marking		ling	g EXH11B-0031		A

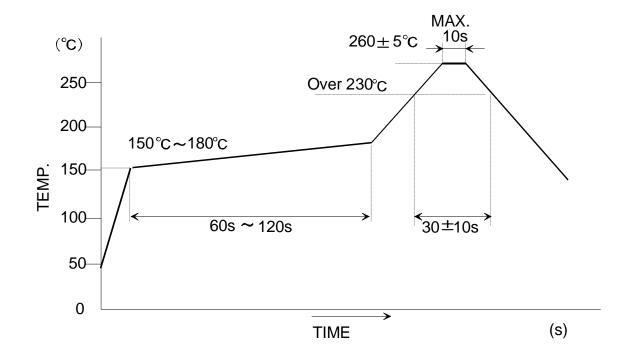
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		e	(page: 1/1)
No.	Test Item	Test Methods	Specification Code
1	High Temperature Storage	+125±3°C 1000h	A,D
2	Low Temperature Storage	-40±3°C 1000h	A,D
3	Temperature Humidity	+85±3°C 80~85%RH 1000h	A,D
4	Temperature Cycling	-55±5°C / +125±5°C It is 1000 cycles using 30 minutes each as 1 cycle.	A,D
5	Vibration	Frequency Range : 10~2000Hz Amplitude or Acceleration : 1.52mm or 196m/s ² 1 cycle : 20 minutes Test time : Three mutually perpendicular axes each 4 hours.	B,D
6	Shock	Devices are shocked to half sine wave (49000m/s ² , 0.15msec) six mutually perpendicular axis each 1 times.	B,D
7	Drop	Devices are dropped from the height 75cm onto iron plate. Execution 3 times random drops.	B,D
8	Solderability	Pre-heat temperature : $+150\pm10^{\circ}$ C Pre-heat time : $60\sim120$ s When the temperature of the specimen is reached at $+215\pm3^{\circ}$ C, it shall be left for 30 ± 1 sec. Material: H63A (Silver $2\sim3\%$) Flux : Rosin resin methyl alcohol solvent (1:4)	С
9	Reflow resistance	Pre-heat temperature : +150~180°C Pre-heat time : 90±30s Heat temperature : more than +230°C Pre-heat time : less than 30s Peak temperature : +260±5°C Peak time : less than 10s	B,D

Reliability assurance item

Specification code	Specification
A	$\Delta f/f \le \pm 20 \text{ ppm}$ $\Delta CI/CI \le \pm 15 \% \text{ or } 5 \Omega \text{ make use larger value}$
В	$\Delta f/f \le \pm 10 \text{ ppm}$ $\Delta CI/CI \le \pm 15 \% \text{ or } 5 \Omega \text{ make use larger value}$
С	The electrodes should be covered by a new solder at least 90% of immersed area.
D	After testing unless cracking of materials view of eyes and unless break of seal.





1.IR reflow condition

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